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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO. 5344
10/823,729	04/14/2004	Takashi Watanabe	042341	
38834 7	590 09/07/2005	EXAMINER		
WESTERMA	N, HATTORI, DANIE	VU, DAVID		
1250 CONNEC	TICUT AVENUE, NW			
SUITE 700			ART UNIT	PAPER NUMBER
WASHINGTO	N, DC 20036	•	2818	

DATE MAILED: 09/07/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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		Application	on No.	Applicant(s)				
		10/823,72	<b>!</b> 9	WATANABE ET AL.				
	Office Action Summary	Examiner		Art Unit				
		DAVID VL		2818				
Period fo	The MAILING DATE of this communication a or Reply	ppears on the	cover sheet with the	correspondence addre	)SS			
THE - Exte after - If the - If NO - Faile Any	MORTENED STATUTORY PERIOD FOR REP MAILING DATE OF THIS COMMUNICATION ensions of time may be available under the provisions of 37 CFR of SIX (6) MONTHS from the mailing date of this communication, e period for reply specified above is less than thirty (30) days, a report of the provision of the	N. 1.136(a). In no eve eply within the statu od will apply and wi tute, cause the appl	ent, however, may a reply be utory minimum of thirty (30) do Il expire SIX (6) MONTHS fro ication to become ABANDON	timely filed  ays will be considered timely. on the mailing date of this comm  NED (35 U.S.C. § 133).	nunication.			
Status								
1)  🏻	Responsive to communication(s) filed on 22	June 2005.						
2a)□								
3)								
-,—	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposit	tion of Claims							
	Claim(s) 1-4,12,13,28 and 29 is/are rejected.  Claim(s) is/are objected to.							
Applicat	tion Papers							
10)⊠	The specification is objected to by the Examination The drawing(s) filed on <u>14 April 2005</u> is/are:  Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct the oath or declaration is objected to by the	a)⊠ accepte he drawing(s) b ection is require	e held in abeyance. Sed if the drawing(s) is c	See 37 CFR 1.85(a). Objected to. See 37 CFR	• •			
Priority	under 35 U.S.C. § 119							
12)⊠ a)	Acknowledgment is made of a claim for foreign All b) Some * c) None of:  1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the priority docume application from the International Bure See the attached detailed Office action for a li	ents have bee ents have bee riority docume eau (PCT Rul	n received. n received in Applica ents have been recei e 17.2(a)).	ation No ved in this National Sta	age			
Attachmer	nt(s)							
	ce of References Cited (PTO-892)		4) Interview Summa					
3) 🛛 Infor	ce of Draftsperson's Patent Drawing Review (PTO-948) rmation Disclosure Statement(s) (PTO-1449 or PTO/SB/0 er No(s)/Mail Date <u>04/14/05</u> .	08)	Paper No(s)/Mail 5) Notice of Informal 6) Other:	Date I Patent Application (PTO-15	52)			

### **DETAILED ACTION**

#### Election/Restrictions

1. Applicant's election without traverse of Species A (Claims 1-4, 12, 13, 28 and 29) on 06/22/2005 is acknowledged.

Claims 5-11, 14-27 and 30-33 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected invention, there being no allowable generic or linking claim. Election was made without traverse in the reply filed on 06/22/2005.

# Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-4, 12, 13, 28 and 29 are rejected under 35 U. S. C. 102(b) as being anticipated by Tan et al. (US Pat. 6,001,706, herein after Tan).

Regarding claims 1-4 and 28-29, Tan discloses a semiconductor device fabrication method comprising the steps of: polishing the surface of a film-to-be-polished 18 formed over a semiconductor substrate 10 by polishing slurry/CMP process (fig. 10A and col. 5, lines 53-62);

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and after the surface of the film-to-be-polished 18 has been planarized, further polishing the surface of the film-to-be-polished 18 by polishing slurry/CMP process one more time (fig. 10B). Note that the CMP method is characterized by polishing a wafer surface with an abrasive cloth (pad) while supplying a polishing solution (slurry) mixed with abrasive grains. {See Koutny, Jr et al. (US 6,171,180) (col. 1, line 60 through col. 2, line 17 or Hsu et al. (US 6,677,239) (col. 1, lines 40-49; col. 10, lines 18-24 and Wang (US 6,046,112) (col. 6, lines 13-17)}.

Regarding claims 12 and 13, Tan discloses that before the step of planarizing the surface of the film-to-be-polished, the steps of: forming over the semiconductor substrate 10 an insulation film (hard mask Si<sub>3</sub>N<sub>4</sub> 14) having polish characteristics different from those of the film-to-be-polished (oxide 18); forming an opening in the insulation film 14; etching the semiconductor substrate 10 with the insulation film 14 as a mask to form a trench in the semiconductor substrate 10 (figs. 7 and 8A); and forming the film-to-be-polished 18 in the trench and over the insulation film 14 (fig. 9A), in the step of further polishing the surface of the film-to-be-polished, the surface of the film-to-be-polished 18 is polished with the insulation film 14 as a stopper (fig. 10A).

## Conclusion

3. Any inquiry concerning this communication or earlier communications from the examiner should be directed to David Vu whose telephone number is (571) 272-1798. The examiner can normally be reached on Monday-Friday from 8:00am to 5:00pm. If attempt to

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reach the examiner by telephone are unsuccessful, the examiner's supervisor, David Nelms can be reached on (571) 272-1787. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR, Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Ghaland

David Vu

September 01, 2005.